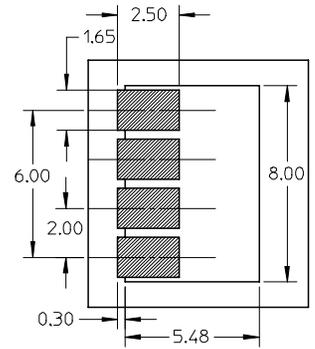
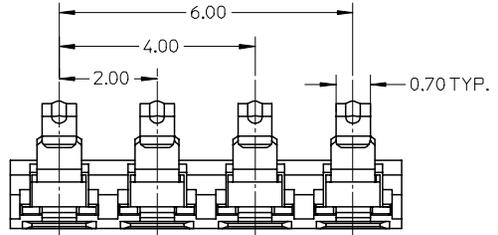
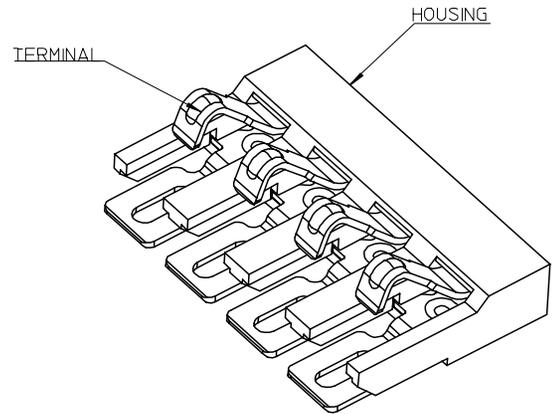
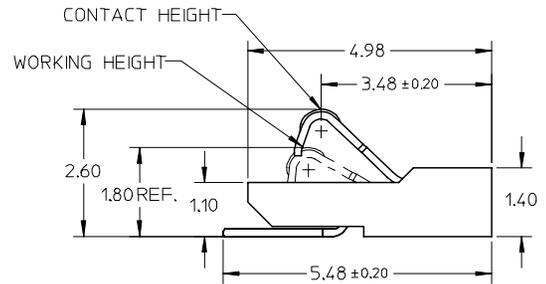
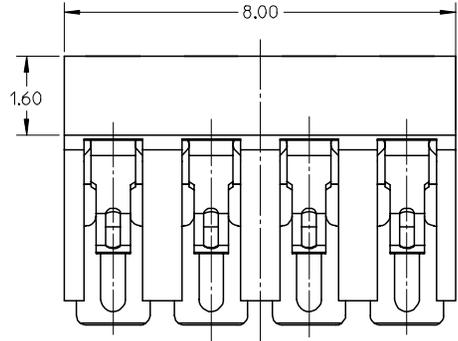


10 9 8 7 6 5 4 3 2 1

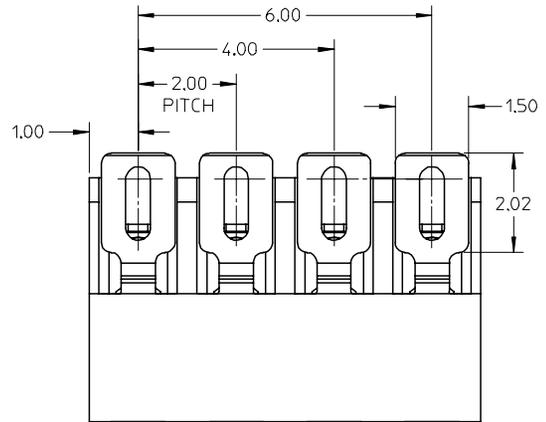
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RECOMMENDED PCB LAYOUT
TOLERANCE: +/- 0.05

- NOTE:
- MATERIAL:
HOUSING: HIGH TEMPERATURE THERMOPLASTIC.COLOR:BLACK
TERMINAL: BeCu-TM04,THICKNESS:0.15mm
 - FINISH:
CONTACT AREA: 0.75 MICRON GOLD MIN OVER 1.25 MICRON NICKEL MIN.
SOLDER AREA: GOLD FLASH (0.075~0.125 MICRON) OVER 1.25 MICRON NICKEL MIN.
REST AREA: 1.25 MICRON NICKEL MIN.
 - COPLANARITY: 0.08 MAX AMONG THESE SOLDER TAILS.
 - PRODUCT SPECIFICATION: PS-47420-001
 - WORKING RANGE: 1.55 - 1.95MM COUNTED FROM TOP OF PCB
 - NORMAL FORCE AT 0.8 DEFLECTION IS 110+/-25 GRAMS.



NEW RELEASE EC NO: SH2007-0482 DRWN: LSHEN 2007/01/18 CHKD: XU XIANG 2007/01/19 APPR: JINCHEN 2007/01/19	QUALITY SYMBOLS ▽=0 △=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY	SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
				DRAWN BY LSHEN	DATE 2006/02/21	TITLE 2.0MM PITCH 4 CIRCUITS 0.7MM CONTACT WIDTH BATTERY CONNECTOR			
				4 PLACES ± --- ± ---	CHECKED BY	DATE	MOLEX INCORPORATED		
				3 PLACES ± --- ± ---	APPROVED BY	DATE	MATERIAL NO. 474200001 DOCUMENT NO. SD-47420-001 SHEET NO. 1 OF 1		
A	REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

9 8 7 6 5 4 3 2 1